

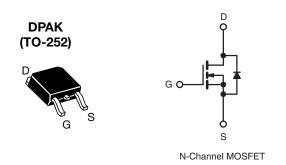
Vishay Siliconix

COMPLIANT HALOGEN

**FREE** 

## **E Series Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700		
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.9	
Q <sub>g</sub> max. (nC)	34		
Q <sub>gs</sub> (nC)	4		
Q <sub>gd</sub> (nC)	8		
Configuration	Sing	le	



#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and Halogen-free	SiHD6N62E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	620		
Gate-Source Voltage			V <sub>GS</sub>	± 30	_ V	
Continuous Drain Current (T, <sub>I</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	,	6		
Continuous Drain Current (1) = 150 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	4	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	12		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	88	mJ	
Maximum Power Dissipation			P <sub>D</sub>	78	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope T <sub>J</sub> = 125 °C			-15.47-11	37	1//	
Reverse Diode dV/dt <sup>d</sup>			dV/dt –	12	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2.5 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ .



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.6	C/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	620	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.76	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
			V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	$I_{GSS}$		V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
			= 620 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	$I_{DSS}$		/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		-	0.78	0.90	Ω
Forward Transconductance	9fs	V <sub>DS</sub>	s = 30 V, I <sub>D</sub> = 3 A	-	1.8	-	S
Dynamic		•					
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		-	578	-	pF
Output Capacitance	C <sub>oss</sub>			-	36	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V 0V 400V V 0V		-	31	-	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 \	/ to 496 V, V <sub>GS</sub> = 0 V	-	87	-	
Total Gate Charge	Qg			-	17	34	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A, V_{DS} = 496 V$	-	4	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	8	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	12	24	
Rise Time	t <sub>r</sub>	V <sub>DD</sub>	= 496 V, I <sub>D</sub> = 3 A,	-	10	20	no
Turn-Off Delay Time	t <sub>d(off)</sub>	00	= 10 V, $R_g = 9.1 \Omega$	-	22	44	ns
Fall Time	t <sub>f</sub>		-	-	16	32	
Gate Input Resistance	$R_g$	f = 1	MHz, open drain	-	1.3	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	7	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers		-	-	12	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	-		-	190	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		25 °C, I <sub>F</sub> = I <sub>S</sub> = 3 A, 100 A/µs, V <sub>B</sub> = 400 V	-	1.3	-	μC
Reverse Recovery Current	I <sub>RRM</sub>		100 AγμS, V <sub>R</sub> = 400 V	_	11	_	A

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

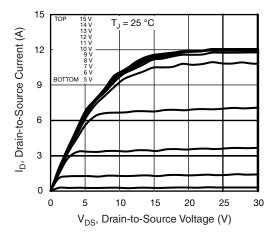


Fig. 1 - Typical Output Characteristics

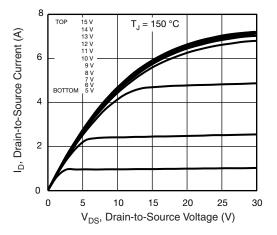


Fig. 2 - Typical Output Characteristics

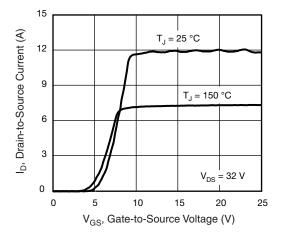


Fig. 3 - Typical Transfer Characteristics

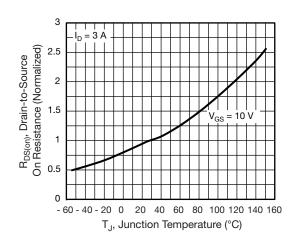


Fig. 4 - Normalized On-Resistance vs. Temperature

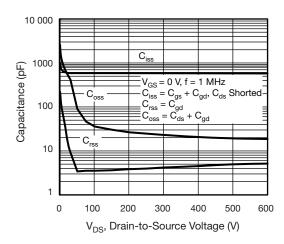


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

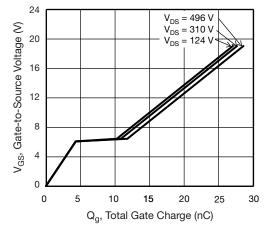


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



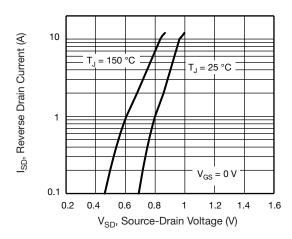


Fig. 7 - Typical Source-Drain Diode Forward Voltage

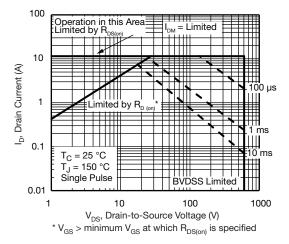


Fig. 8 - Maximum Safe Operating Area

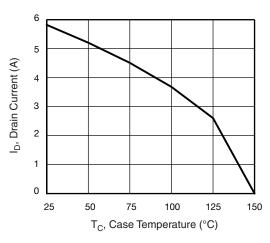


Fig. 9 - Maximum Drain Current vs. Case Temperature

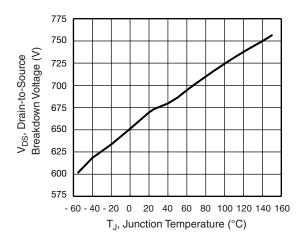


Fig. 10 - Temperature vs. Drain-to-Source Voltage

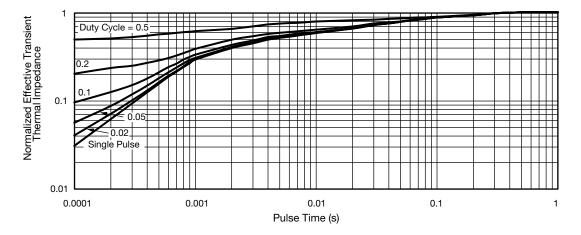


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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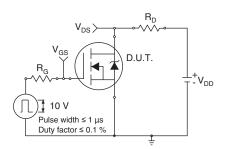


Fig. 12 - Switching Time Test Circuit

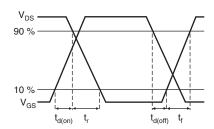


Fig. 13 - Switching Time Waveforms

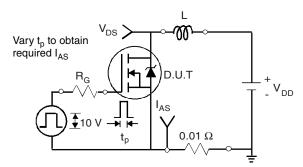


Fig. 14 - Unclamped Inductive Test Circuit

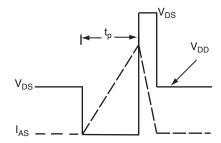


Fig. 15 - Unclamped Inductive Waveforms

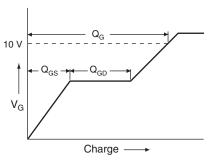


Fig. 16 - Basic Gate Charge Waveform

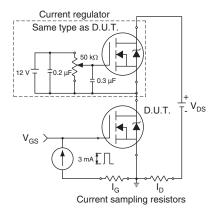
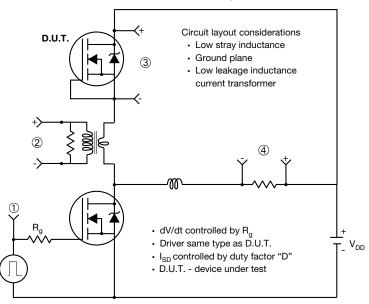


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



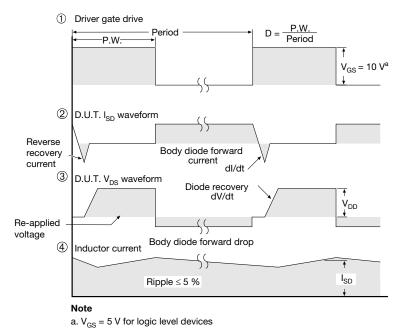


Fig. 18 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91558">www.vishay.com/ppg?91558</a>.

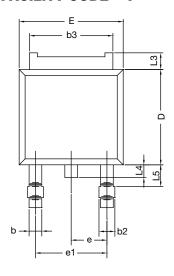
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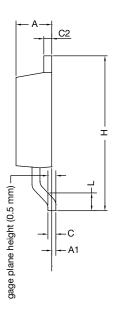


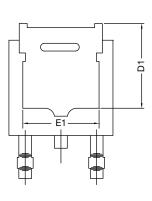
## **TO-252AA Case Outline**

## **VERSION 1: FACILITY CODE = Y**

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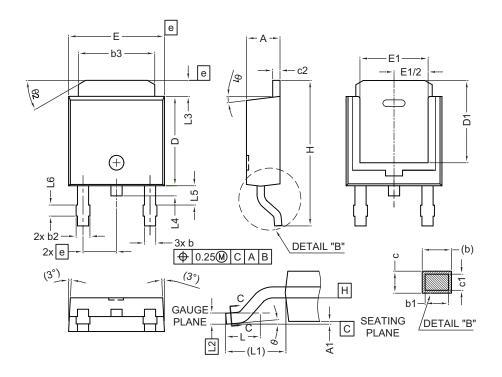
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56	BSC	
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

#### Note

• Dimension L3 is for reference only



### **VERSION 2: FACILITY CODE = N**



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32	=	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

### Notes

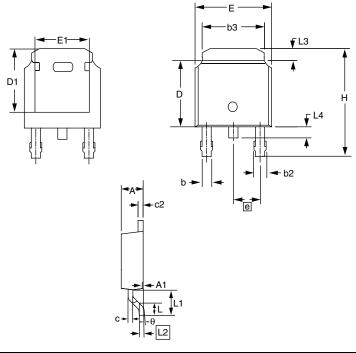
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



## **TO-252AA (HIGH VOLTAGE)**



MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Е	6.40	6.73	0.252	0.265	
L	1.40	1.77	0.055	0.070	
L1	2.743	REF	0.108 REF		
L2	0.508	BSC	0.020	0.020 BSC	
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.286 BSC		0.090 BSC		
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

ECN: S-81965-Rev. A, 15-Sep-08

DWG: 5973

#### Notes

- 1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.
- 2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- 3. The package top may be smaller than the package bottom.
- 4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

Document Number: 91344 www.vishay.com Revision: 15-Sep-08



## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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